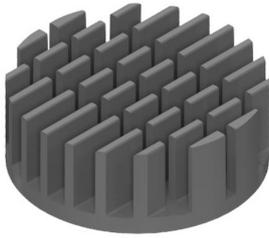


Data sheet Product ICKLEDR54x20G_



Heatsinks and active heatsinks for processors>Heatsinks for LEDs
 Ø 54 x 20 mm, for IC design LED

Features

diameter:	54 mm
way of fixation:	<ul style="list-style-type: none"> • therm. conductive foil • therm. cond. adhesive
height:	20 mm
plate thickness:	4 mm
thermal resistance:	9.78 - 1.9 K/W
dissipation loss:	11.9 W
surface:	black anodised

Technical Drawing

